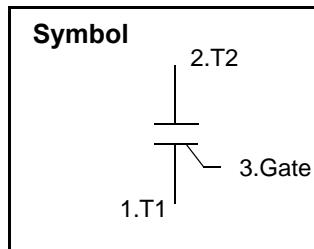


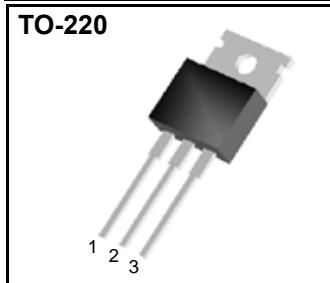
Triacs / Sensitive Gate

Features

Repetitive Peak Off-State Voltage : 600V
 R.M.S On-State Current ($I_{T(RMS)} = 4 \text{ A}$)
 High Commutation dv/dt
 Sensitive Gate Triggering 4 Mode
 Non-isolated Type



$BV_{DRM} = 600\text{V}$
 $I_{T(RMS)} = 4 \text{ A}$
 $I_{TSM} = 40 \text{ A}$



General Description

This device is sensitive gate triac suitable for direct coupling to TTL, HTL, CMOS and application such as various logic functions, low power AC switching applications, such as fan speed, small light controllers and home appliance equipment.

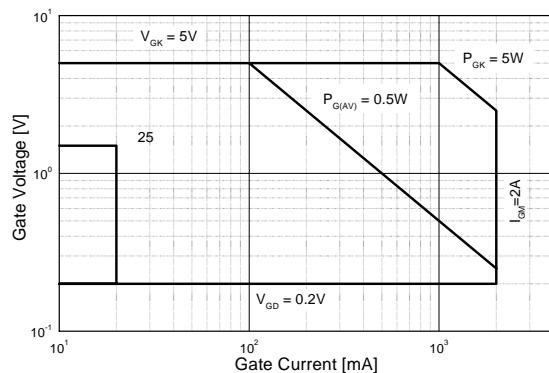
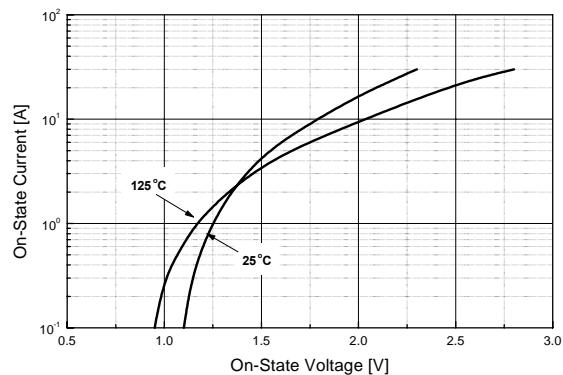
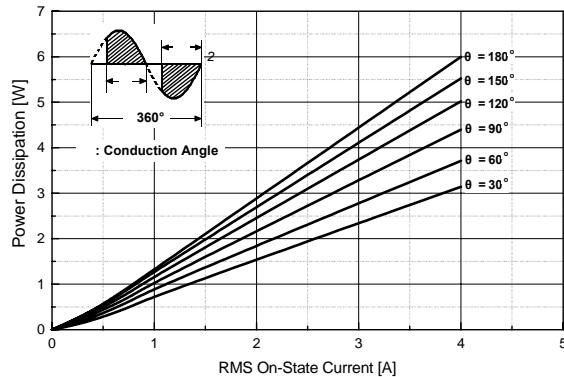
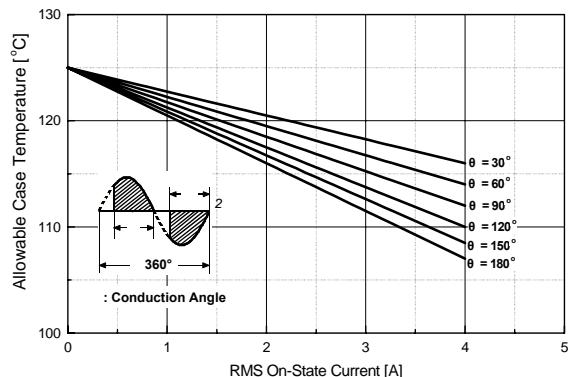
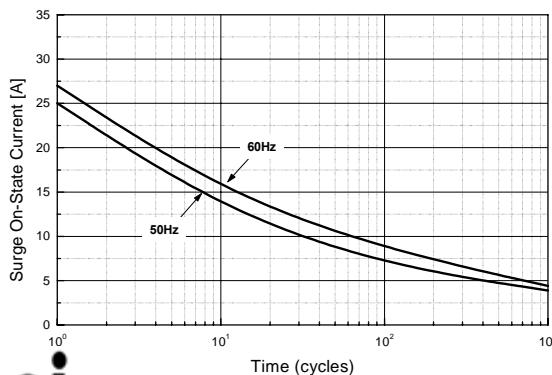
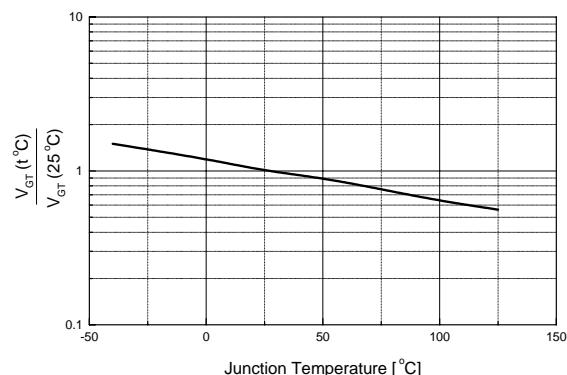
Absolute Maximum Ratings ($T_J = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Condition	Ratings	Units
V_{DRM}	Repetitive Peak Off-State Voltage	Sine wave, 50 to 60 Hz, Gate open	600	V
$I_{T(RMS)}$	R.M.S On-State Current	$T_C = 107^\circ\text{C}$, Full Sine wave	4	A
I_{TSM}	Surge On-State Current	One Cycle, 50Hz/60Hz, Peak, Non-Repetitive	40/44	A
I^2t	I^2t for Fusing	$t_p = 10\text{ms}$	3.1	A^2s
P_{GM}	Peak Gate Power Dissipation	$T_C = 107^\circ\text{C}$, Pulse width 1.0us	5	W
$P_{G(AV)}$	Average Gate Power Dissipation	Over any 20ms period	0.5	W
I_{GM}	Peak Gate Current	$t_p = 20\text{us}$, $T_J=125^\circ\text{C}$	2	A
V_{GM}	Peak Gate Voltage	$t_p = 20\text{us}$, $T_J=125^\circ\text{C}$	5	V
T_J	Operating Junction Temperature		- 40 ~ 125	$^\circ\text{C}$
T_{STG}	Storage Temperature		- 40 ~ 150	$^\circ\text{C}$

DBT136-600

Electrical Characteristics

Symbol	Items	Conditions	Ratings			Unit
			Min.	Typ.	Max.	
I_{DRM}	Repetitive Peak Off-State Current	$V_D = V_{DRM}$, Single Phase, Half Wave $T_J = 125^\circ C$			0.5	mA
V_{TM}	Peak On-State Voltage	$I_T = 5 A$, Inst. Measurement		1.4	1.7	V
I^+_{GT1}	Gate Trigger Current	$V_D = 6 V$, $R_L=10$			5	mA
I^-_{GT1}					5	
I^-_{GT3}					5	
I^+_{GT3}					10	
V^+_{GT1}	Gate Trigger Voltage	$V_D = 6 V$, $R_L=10$			1.5	V
V^-_{GT1}					1.5	
V^-_{GT3}					1.5	
V^+_{GT3}					2.5	
V_{GD}	Non-Trigger Gate Voltage	$T_J = 125^\circ C$, $V_D = 1/2 V_{DRM}$	0.2			V
$(dv/dt)_C$	Critical Rate of Rise Off-State Voltage at Commutation	$T_J = 125^\circ C$, $[di/dt]_C = -0.75 A/ms$, $V_D=2/3 V_{DRM}$	5.0			V/ μ s
I_H	Holding Current			5		mA
$R_{th(j-c)}$	Thermal Impedance	Junction to case			3.0	°C/W
$R_{th(j-a)}$	Thermal Impedance	Junction to Ambient (In the free air)			60	°C/W

DBT136-600**Fig 1. Gate Characteristics****Fig 2. On-State Voltage****Fig 3. On State Current vs. Maximum Power Dissipation****Fig 4. On State Current vs. Allowable Case Temperature****Fig 5. Surge On-State Current Rating (Non-Repetitive)****Fig 6. Gate Trigger Voltage vs. Junction Temperature**

DBT136-600

Fig 7. Gate Trigger Current vs. Junction Temperature

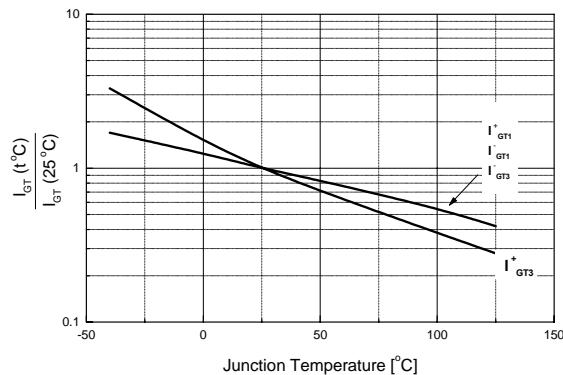


Fig 8. Transient Thermal Impedance

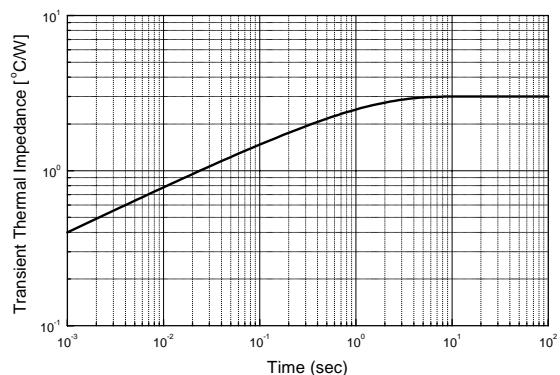
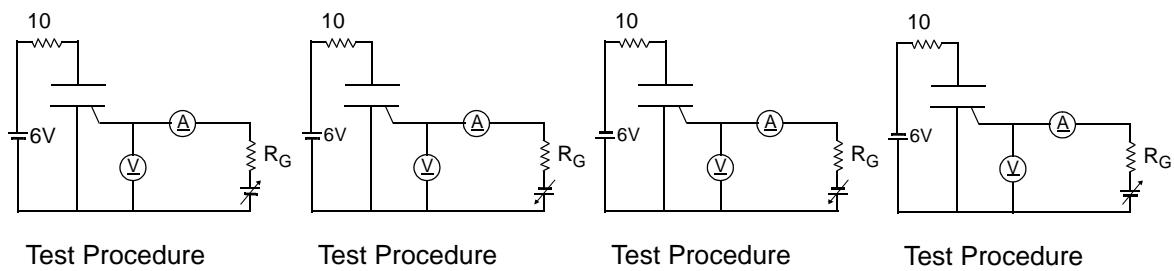


Fig 9. Gate Trigger Characteristics Test Circuit



DBT136-600**TO-220 Package Dimension**

Dim.	mm			Inch		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	9.7		10.1	0.382		0.398
B	6.3		6.7	0.248		0.264
C	9.0		9.47	0.354		0.373
D	12.8		13.3	0.504		0.524
E	1.2		1.4	0.047		0.055
F		1.7			0.067	
G		2.5			0.098	
H	3.0		3.4	0.118		0.134
I	1.25		1.4	0.049		0.055
J	2.4		2.7	0.094		0.106
K	5.0		5.15	0.197		0.203
L	2.2		2.6	0.087		0.102
M	1.25		1.55	0.049		0.061
N	0.45		0.6	0.018		0.024
O	0.6		1.0	0.024		0.039
		3.6			0.142	

